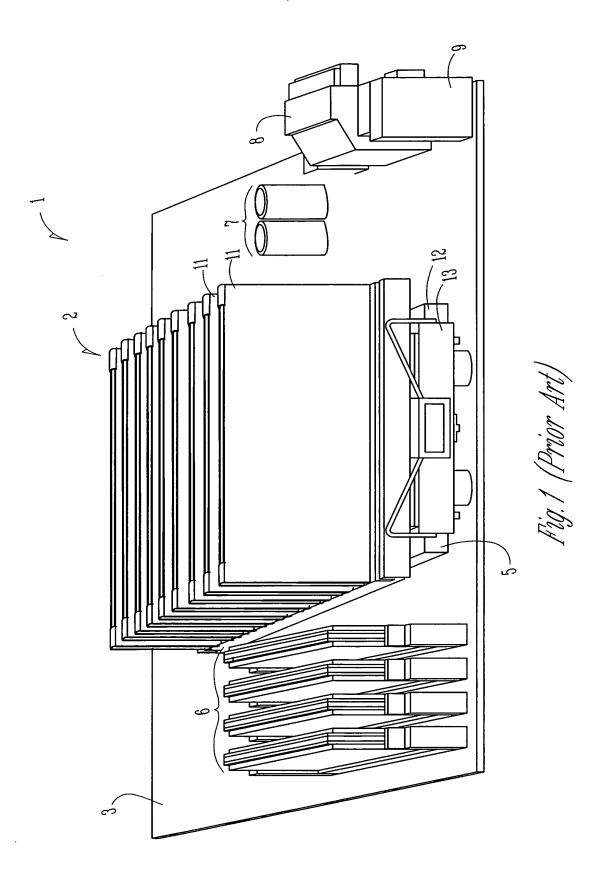
Dkt #: 884.467US3



Dkt #: 884.467US3

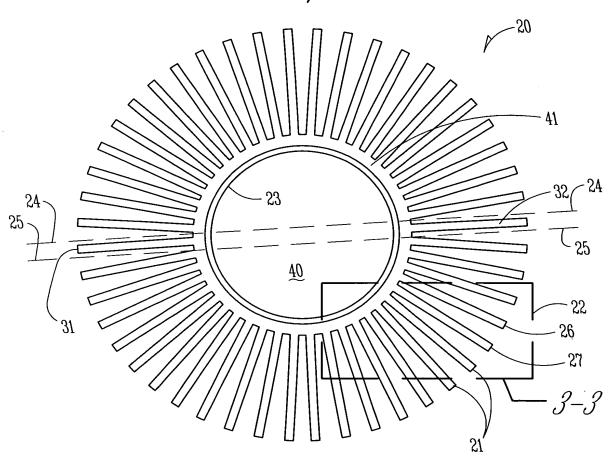


Fig.2 (Prior Art)

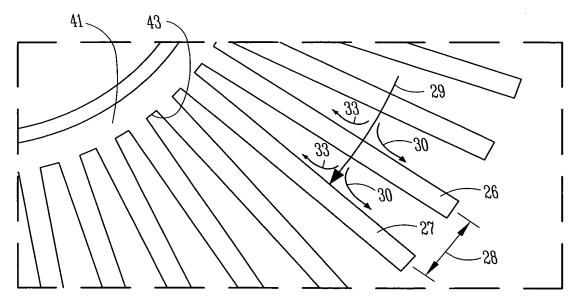
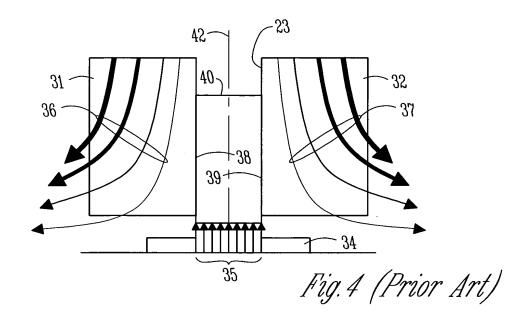


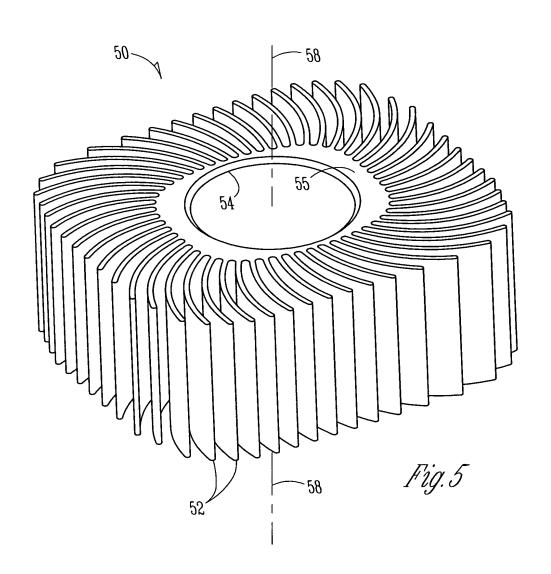
Fig.3 (Prior Art)

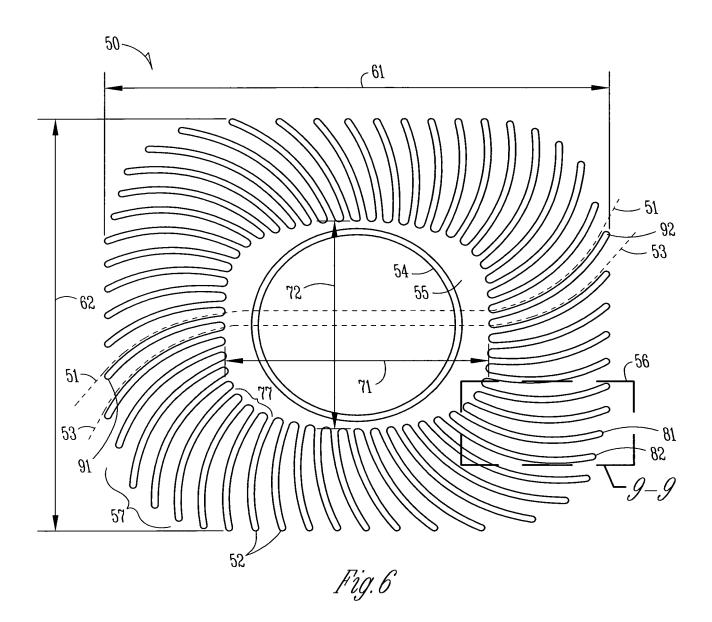
TITLE: ELECTRONIC ASSEMBLIES WITH HIGH CAPACITY HEAT SINKS INVENTORS NAME: Daniel P. Carter et al.

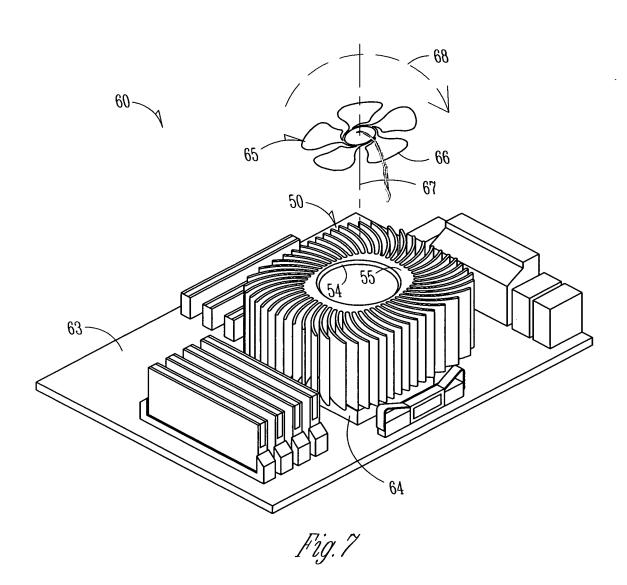
Dkt #: 884.467US3

3/18

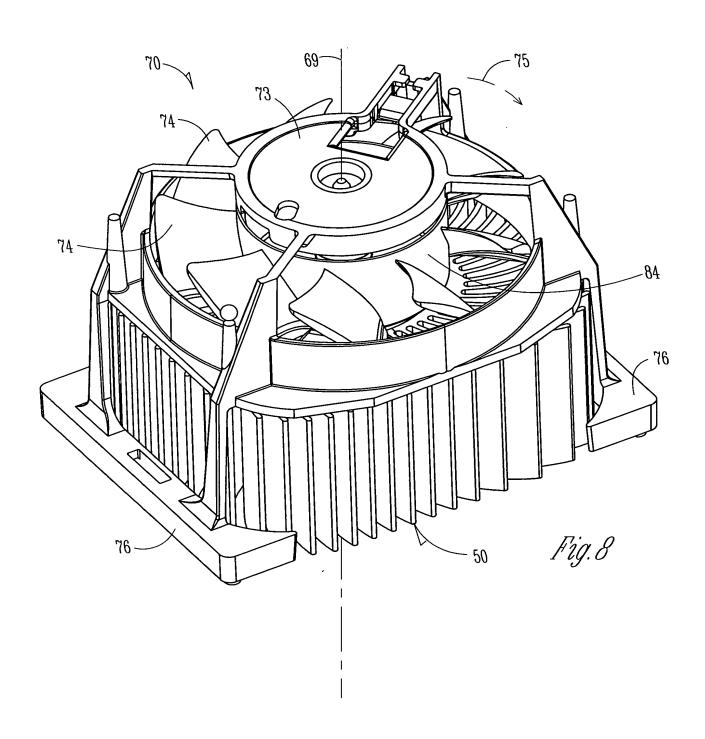








Dkt #: 884.467US3



Dkt #: 884.467US3

7/18

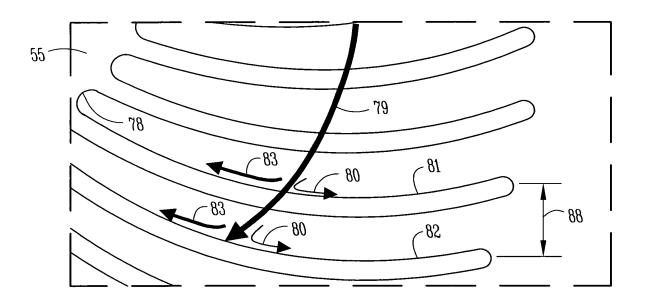
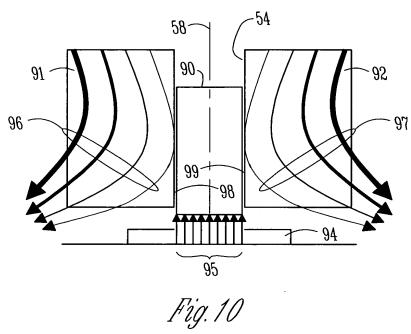
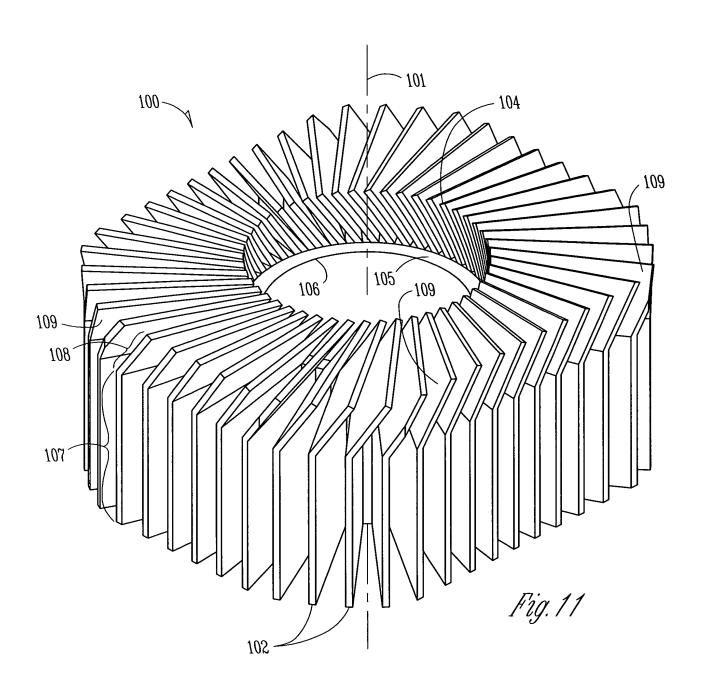
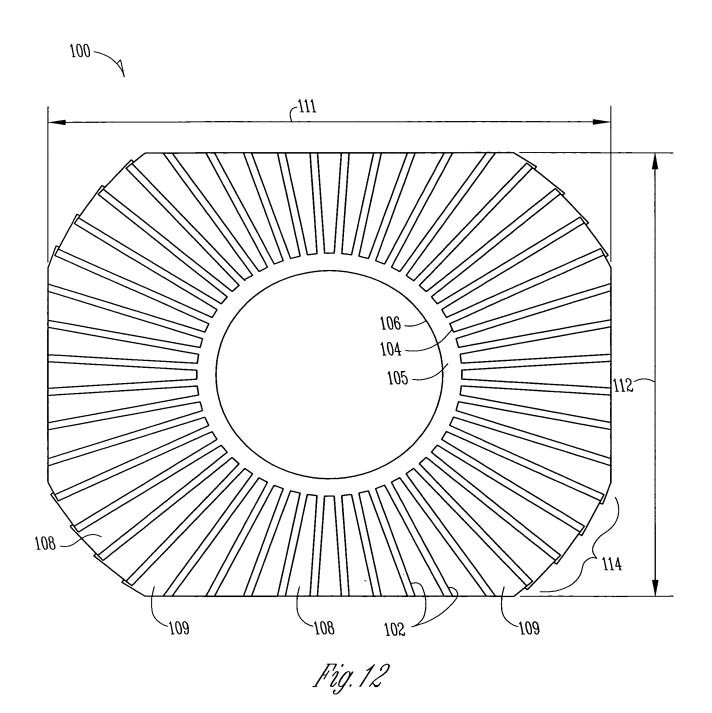


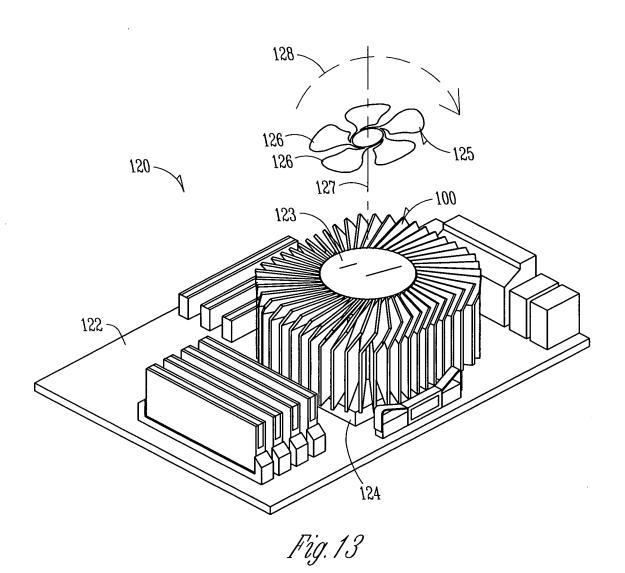
Fig. 9





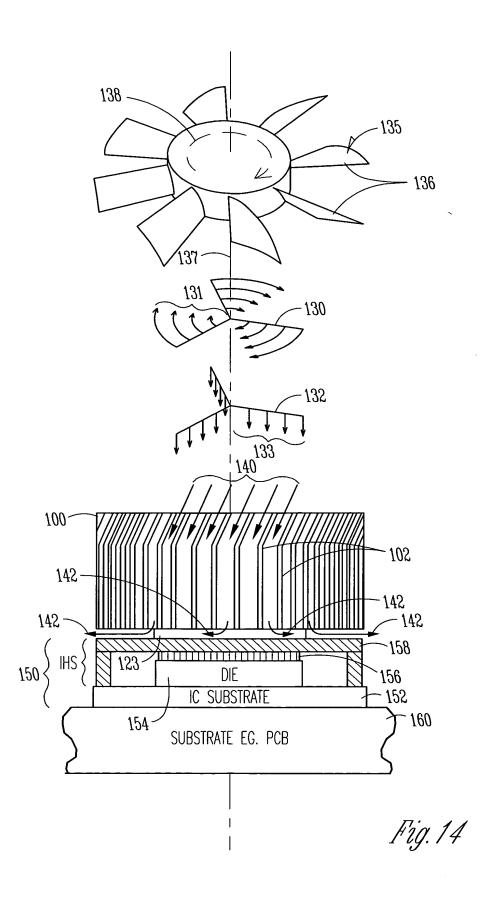
Dkt #: 884.467US3





Dkt #: 884.467US3

11/18



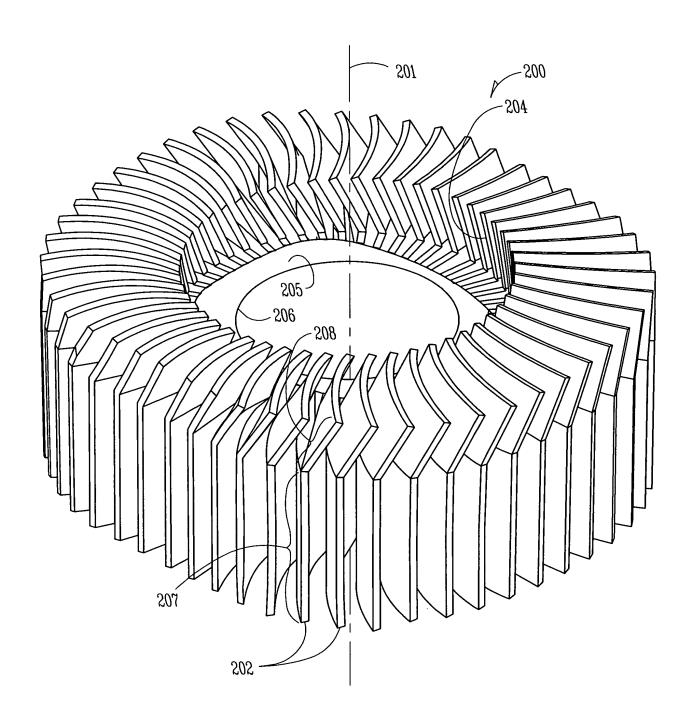
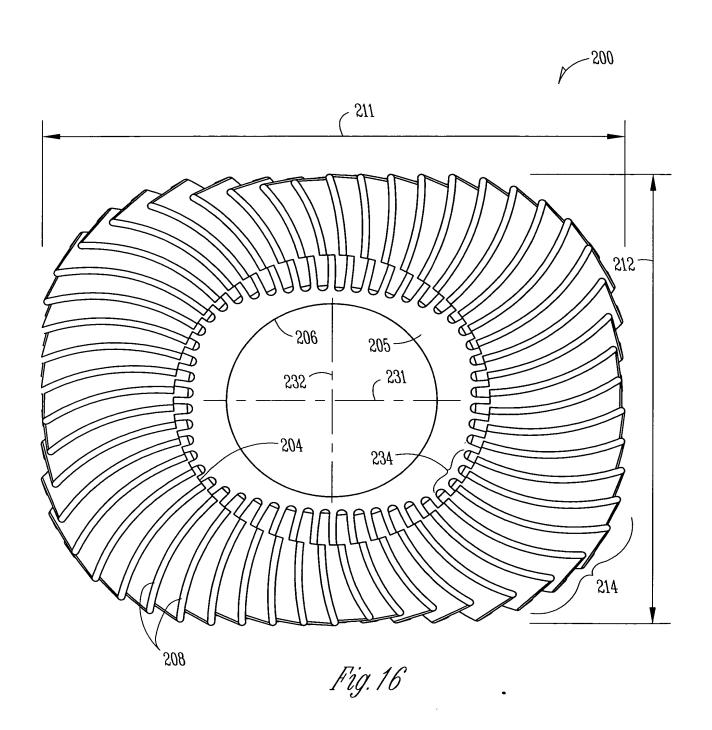
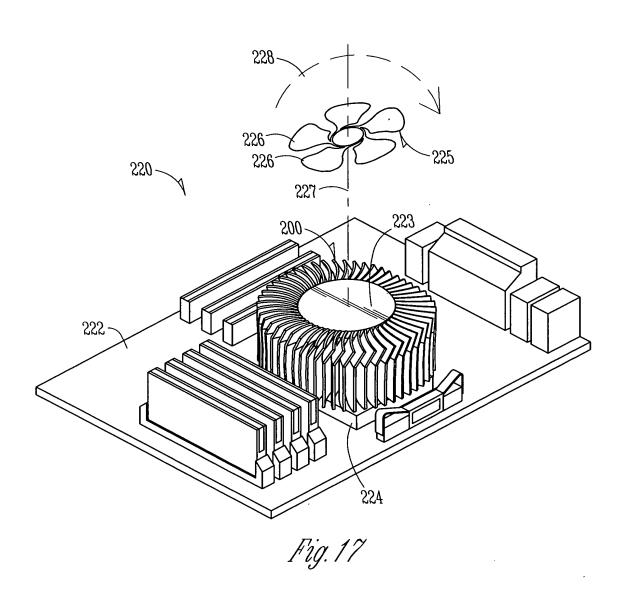


Fig. 15

Dkt #: 884.467US3

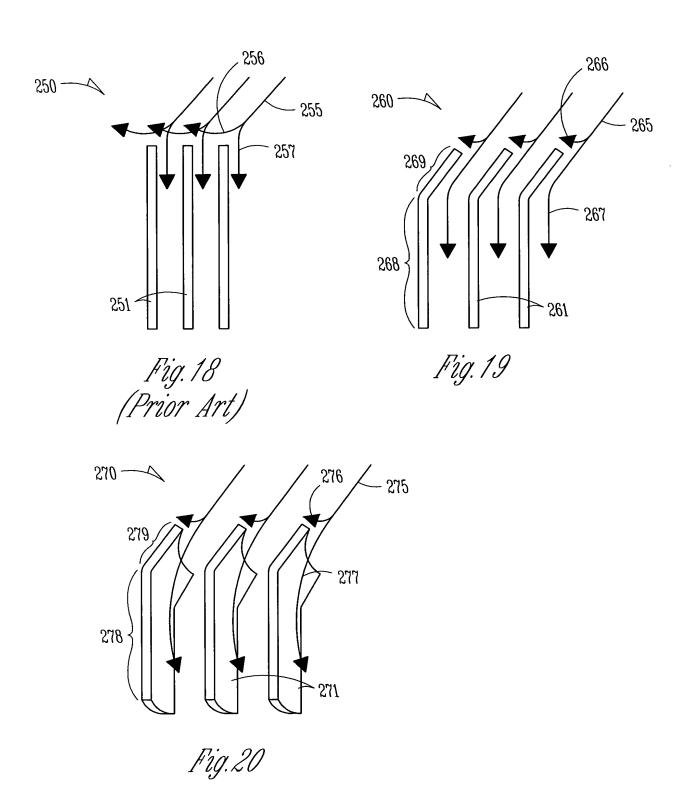




TITLE: ELECTRONIC ASSEMBLIES WITH HIGH CAPACITY HEAT SINKS

INVENTORS NAME: Daniel P. Carter et al.

Dkt #: 884.467US3



Dkt #: 884.467US3



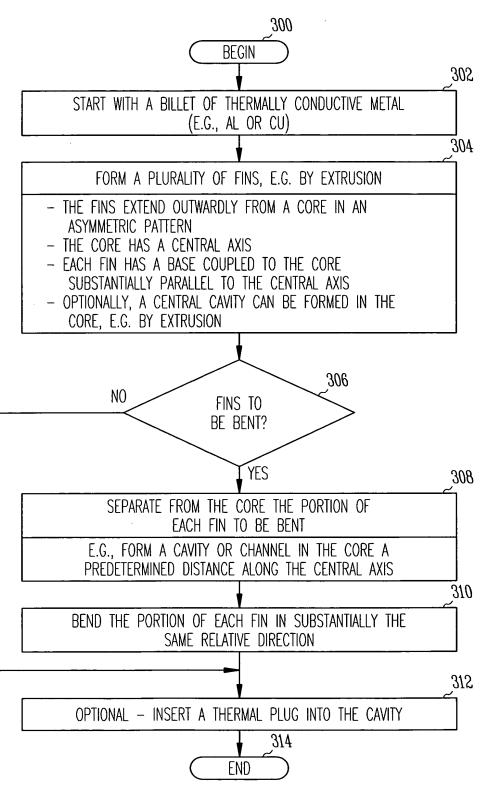


Fig.21

Dkt #: 884.467US3

17/18

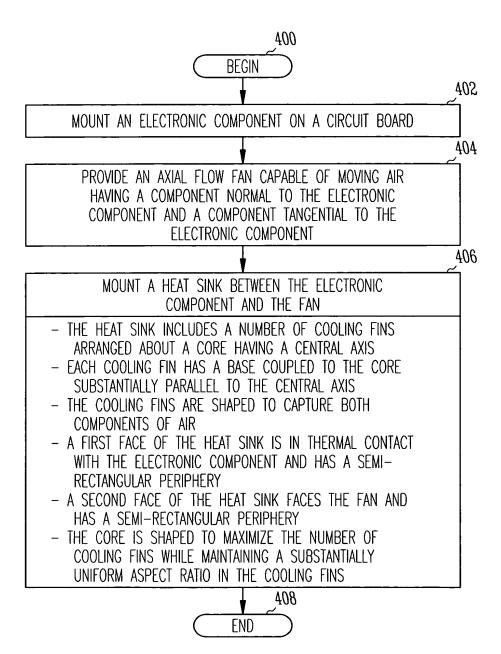


Fig.22

Dkt #: 884.467US3

18/18

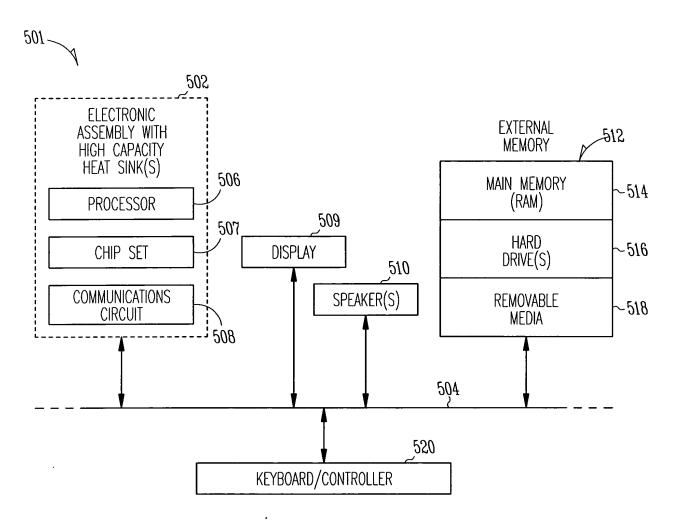


Fig.23